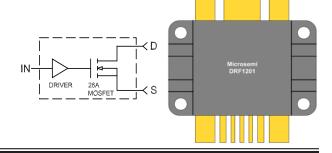


DRF1201 PRELIMINARY

1000V, 26A, 30MHz

MOSFET Driver Hvbrid

The DRF1201 hybrid includes a high power gate driver and the power MOSFET. The driver output can be configured as Inverting and Non-Inverting. It was designed to provide the system designer increased flexibility and lowered cost over a non-integrated solution.



FEATURES

- Switching Frequency: DC TO 30MHz
- Low Pulse Width Distortion
- · Single Power Supply
- 1V CMOS Schmitt Trigger Input 1V Hysteresis
- · Inverting Non-Inverting Select
- RoHS Compliant

- · Switching Speed 3-4ns B_{Vds} = 1Kv
- I_{ds} = 26A avg.
- R_{ds(on)} ≤ .55 Ohm
- P_D = 1100W

TYPICAL APPLICATIONS

- · Class C, D and E RF Generators
- · Switch Mode Power Amplifiers
- Pulse Generators
- Ultrasound Transducer Drivers
- · Acoustic Optical Modulators

Driver Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
$V_{_{\mathrm{DD}}}$	Supply Voltage	18	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
IN, FN	Input Single Voltages	7 to +5.5	V
I _{O PK}	Output Current Peak	8	Α
T_{JMAX}	Operating Temperature	175	°C

Driver Specifications

Symbol	Parameter	Min	Тур	Max	Unit
$V_{_{\mathrm{DD}}}$	Supply Voltage	8	15	18	V
IN	Input Voltage	3		5.5	V
IN _(R)	Input Voltage Rising Edge		3		
IN _(F)	Input Voltage Falling Edge		3		ns
I _{DDQ}	Quiescent Current		2		mA
I _o	Output Current	ĺ	8		Α
C _{oss}	Output Capacitance		2500		
C _{iss}	Input Capacitance		3		pF
R _{IN}	Input Parallel Resistance		1		mΩ
$V_{T(ON)}$	Input, Low to High Out	0.8		1.1	V
$V_{T(OFF)}$	Input, High to Low Out	1.9		2.2	V
T _{DLY}	Time Delay (throughput)		38		ns
t _r	Rise Time		5		
t _r	Fall Time		5		ns
T _D	Prop. Delay		35		

MOSFET Absolute Maximum Ratings

DRF1201

Symbol Parameter		Min	Тур	Max	Unit
BV _{DSS} Drain Source Voltage		1000			٧
I _D	Continuous Drain Current T _{HS} = 25°C			26	Α
R _{DS(on)}	Drain-Source On State Resistance		0.55		Ω

Dynamic Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
C _{iss}	Input Capacitance		2000		
C _{oss}	Output Capacitance		165		pF
C _{rss}	Reverse Transfer Capacitance		75		

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R _{θJc}	Thermal Resistance Junction to Case	0.09	°C/W
R _{ØJHS}	Thermal Resistance Junction to Heat Sink	0.24	C/VV
T _{JSTG}	Storage Temperature	-55 to 150	°C
P _D	Maximum Power Dissipation @ T _{SINK} = 25°C	1100	w
P _{DC}	Total Power Dissipation @ T _C = 25°C	2900	

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

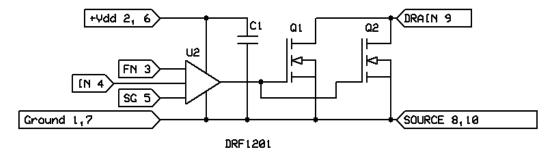


Figure 1, DRF1201 Simplified Circuit Diagram

The Simplified DRF1201 Circuit Diagram is illustrated above. By including the driver high speed by-pass capacitor (C1), the contribution to the internal parasitic loop inductance of the driver output is greatly reduced. This, coupled with the tight geometry of the hybrid, allows optimal gate drive to the MOSFET. This low parasitic approach, coupled with the Schmitt trigger input (IN), Kelvin signal ground (SG) and the Anti-Ring Function, provide improved stability and control in Kilowatt to Multi-Kilowatt, high Frequency applications. Both the FN and IN pins are referenced to the Kelvin ground (SG.) The signal is then applied to the intermediate drivers and level shifters; this section contains proprietary circuitry designed specifically for the ring abatement. The power drivers provide high current to the gate of the MOSFETS.

The Function (FN, pin 3) is the invert or non-invert select Pin, it is Internally held high, Normally Non-inverting.

Truth Table *Referenced to SG				
FN (pin 3)* IN (pin 4)* MOSFET		Function		
HIGH	HIGH	ON	Non-Invert	
HIGH	LOW	OFF	Non-Invert	
LOW HIGH OFF		Inverting		
LOW	LOW	ON	Inverting	

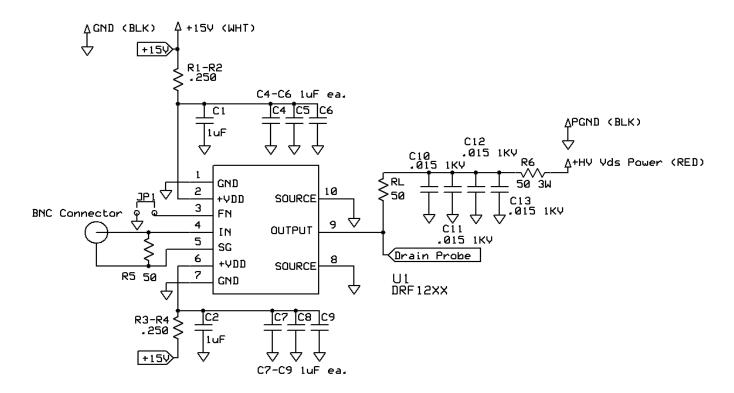
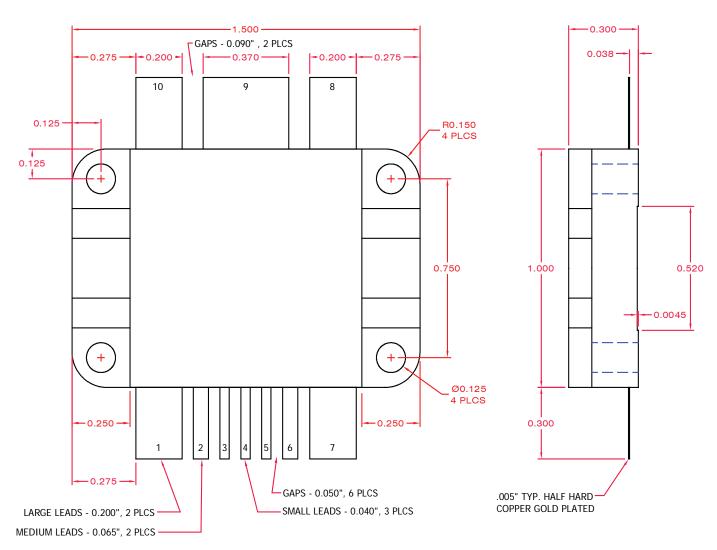


Figure 2, DRF1201 Test Circuit

The Test Circuit illustrated above was used to evaluate the DRF1201 (available as an evaluation Board DRF12XX / EVALSW.) The input control signal is applied to the DRF1201 via IN(4) and SG(5) pins using RG188. This provides excellent noise immunity and control of the signal ground currents.

The +V_{DD} inputs (2,6) are by-passed (C1, C2, C4-C9), this is in addition to the internal by-passing mentioned previously. The capacitors used for this function must be capable of supporting the RMS currents and frequency of the gate load. A 50Ω (RL) load is used to evaluate the output performance of the DRF1201.

Pin Assignments		
Pin 1	Ground	
Pin 2	U1 +Vdd	
Pin 3	FN	
Pin 4	U1 IN	
Pin 5	U1 SG	
Pin 6	U1 +Vdd	
Pin 7	Ground	
Pin 8	Source	
Pin 9 Drain		
Pin 10	Source	



All dimensions are ± .005

Figure 3, DRF1201 Mechanical Outline